AMP-LATCH

TE Internal #: 746613-3

Ribbon Cable Connectors, Wire-to-Board, 16 Position, 2.54mm [.

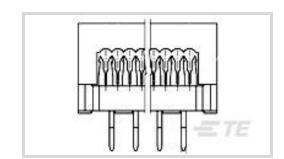
1in] Centerline, Vertical, Through Hole - Solder, Insulation

Displacement Crimp (IDC)

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Wire-to-Board

Number of Positions: 16

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: Without
PCB Mount Orientation: Vertical

Features

Product Type Features

Connector Type	Connector Assembly
Ribbon Cable Connector Header Type	Pin Header
Connector Product Type	Connector Assembly
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board, Wire & Cable

Configuration Features

Number of Positions	16
PCB Mount Orientation	Vertical
Number of Rows	2

Electrical Characteristics

UL Voltage Rating	250 VAC
Insulation Resistance	5000 MΩ
Operating Voltage	250 VAC

Body Features

Daisy Chain	Without
Connector Profile	Standard

Contact Features



Contact Layout	Inline
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Type	Pin
Wire Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Wire Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	1 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.32 mm[.013 in]
Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Termination Post & Tail Length	3.94 mm[.155 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Method to Wire & Cable	Insulation Displacement Crimp (IDC)
Mechanical Attachment	
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Mating Alignment Type	Polarization
Mating Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Thermoplastic
Housing Color	Black
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Connector Length	22.56 mm[.8882 in]
Connector Height	6.43 mm[.253 in]
Connector Width	10.67 mm[.42 in]
Wire Size	.051 – .15 mm²
PCB Thickness (Recommended)	3.18 mm[.125 in]



Accepts Wire Insulation Diameter Range	.81 – 1.07 mm[.032 – .042 in]
Row-to-Row Spacing	2 mm[.1 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Solder Dipped
Circuit Application	Signal
Industry Standards	
CSA File Number	LR 7189
UL Rating	Recognized
Agency/Standard	CSA, UL
UL File Number	E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	180

Box & Tray, Tray

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2020 (205) Candidate List Declared Against: JUN 2015 (163) Does not contain REACH SVHC
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2020 (205) Candidate List Declared Against: JUN 2015 (163)
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts





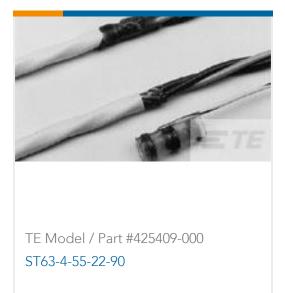
Customers Also Bought









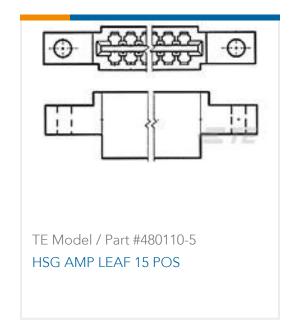












Documents

Product Drawings

16 DIP PLUG CONN-W/COVER

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_746613-3_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_746613-3_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_746613-3_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English

Agency Approvals

Agency Approval Document

English